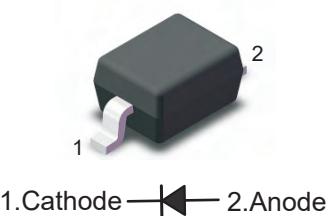


Features

- For surface mount applications
- Glass passivated chip junction
- Low profile package
- Fast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directive

SOD-323



1.Cathode 2.Anode

Marking Code:

BAV19WS: A8

BAV20WS: T2

BAV21WS: T3

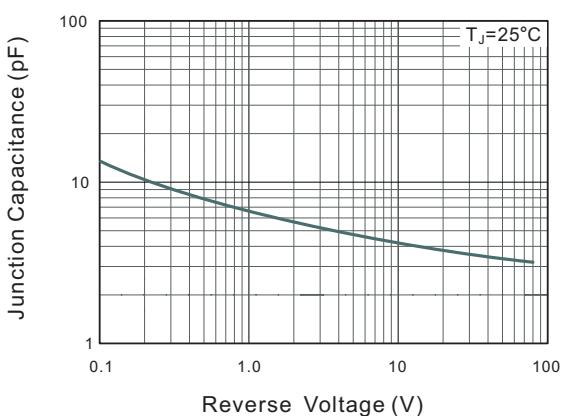
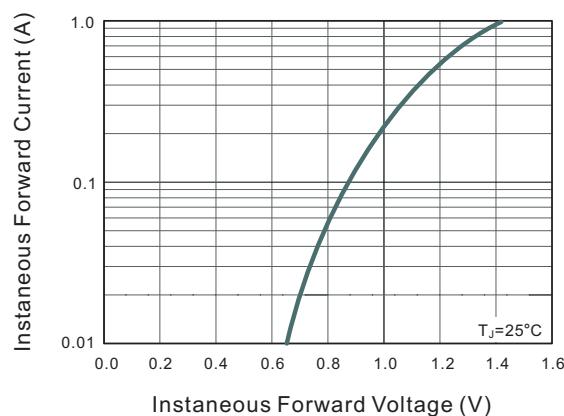
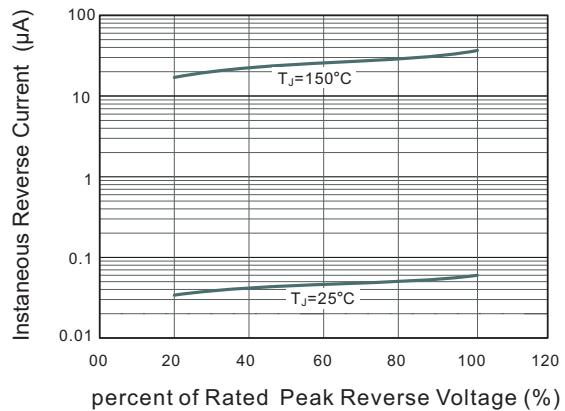
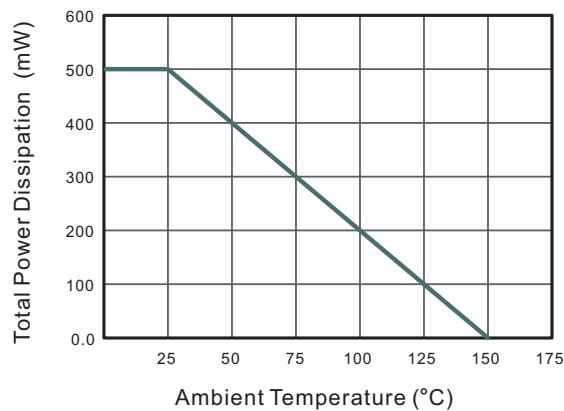
Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$

Parameter	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	120	V
		200	
		250	
Maximum RMS Voltage	V_{RMS}	100	V
		150	
		200	
Continuous Forward Current	I_F	250	mA
Repetitive Peak Forward Current	I_{FRM}	625	mA
Non-repetitive Peak Forward Surge Current at $t = 1 \text{ s}$ at $t = 1 \text{ ms}$ at $t = 1 \mu\text{s}$	I_{FSM}	1	A
		3	
		9	
Power Dissipation	P_D	500	mW
Junction Temperature	T_J	500	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Characteristics at $T_A = 25^\circ\text{C}$

Parameter		Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 100 \mu\text{A}$	BAV19WS	$V_{(\text{BR})R}$	120	--	V
	BAV20WS		200	--	
	BAV21WS		250	--	
Maximum Forward Voltage at $I_F = 100 \text{ mA}$ at $I_F = 200 \text{ mA}$		V_F	-- --	1 1.25	V
Maximum DC Reverse Current at Rated DC Blocking Voltage at $T_A = 25^\circ\text{C}$ at $T_A = 150^\circ\text{C}$		I_R	-- --	0.1 100	μA
Typical Junction Capacitance at $V_R = 4 \text{ V}$, $f = 1 \text{ MHz}$		C_j	--	5	pF
Maximum Reverse Recovery Time at $I_F = 0.5 \text{ A}$, $I_{rr} = 0.25 \text{ A}$, $I_R = 1 \text{ A}$		T_{rr}	--	50	nS

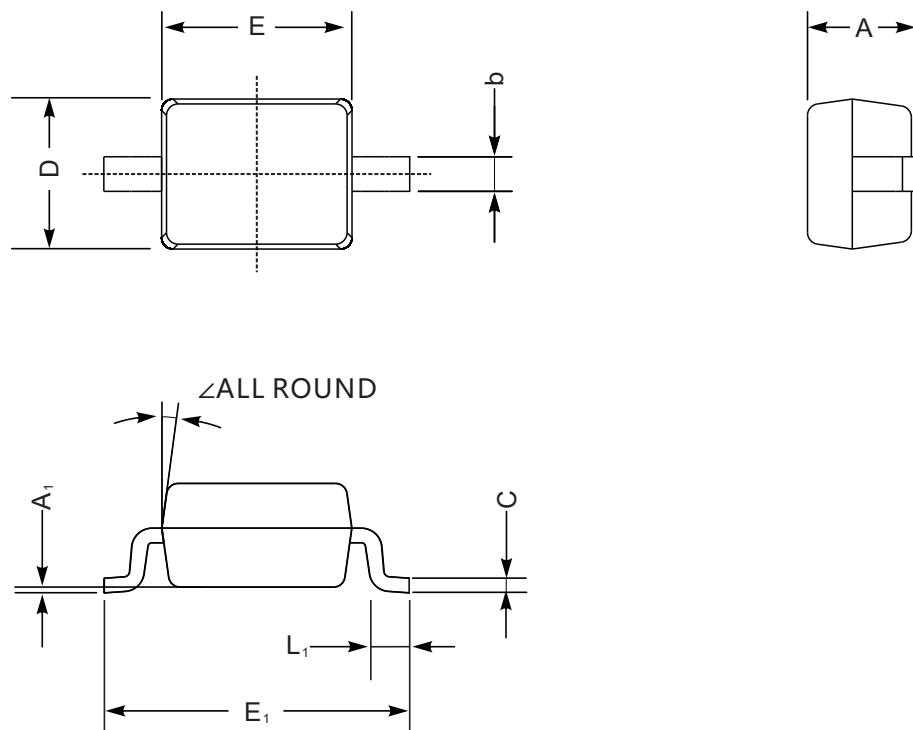
Typical Characteristic Curves



Package Outline

SOD-323

Dimensions in mm



UNIT		A	C	D	E	E_1	b	L_1	A_1	\angle
mm	max	1.1	0.15	1.4	1.8	2.75	0.4	0.45	0.2	9°
	min	0.8	0.08	1.2	1.4	2.55	0.25	0.2	—	
mil	max	43	5.9	55	70	108	16	16	8	9°
	min	32	3.1	47	63	100	9.8	7.9	—	